

## **MOSFET**

### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V

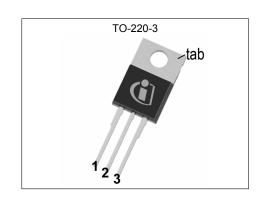
### **Features**

- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)

- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  Very low reverse recovery charge (Q<sub>rr)</sub>
  175 °C operating temperature
  Pb-free lead plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target application
  Ideal for high-frequency switching and synchronous rectification
  Halogen-free according to IEC61249-2-21



Table 1 Rey 1 circimance 1 arameters							
Parameter	Value	Unit					
V <sub>DS</sub>	150	V					
R <sub>DS(on),max</sub>	7.6	mΩ					
$I_{D}$	112	A					
Q <sub>rr</sub>	96	nC					











Type / Ordering Code	Package	Marking	Related Links
IPP076N15N5	PG-TO220-3	076N15N5	-

# OptiMOS<sup>™</sup>5 Power-Transistor, 150 V IPP076N15N5



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## OptiMOS<sup>™</sup>5 Power-Transistor, 150 V . IPP076N15N5



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Cumbal		Values			Note / To at O and little or	
Parameter	Symbol	Min.	Тур.	Тур. Мах.		Note / Test Condition	
Continuous drain current	I <sub>D</sub>	-	-	112 79	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C	
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	-	-	448	Α	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>2)</sup>	<b>E</b> AS	-	-	130	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	214	W	<i>T</i> <sub>C</sub> =25 °C	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

#### Thermal characteristics 2

Table 3 Thermal characteristics

Davamatav	Cumbal	Values			11:4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	0.4	0.7	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-	

#### 3 **Electrical characteristics**

Table 4 **Static characteristics** 

Dayamatay	C: mah al		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	150	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 160 \ \mu {\rm A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	5.9 6.4	7.6 8.4	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =56 A V <sub>GS</sub> =8 V, I <sub>D</sub> =28 A	
Gate resistance <sup>3)</sup>	<b>R</b> <sub>G</sub>	-	1.1	1.7	Ω	-	
Transconductance	<b>g</b> fs	45	90	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 56 A$	

See Diagram 3
 See Diagram 13
 Defined by design. Not subject to production test.

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**Table 5** Dynamic characteristics

Parameter	Oh a l		Values			Nata / Tank Oam Jiti an	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	Ciss	-	3600	4700	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	900	1200	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Reverse transfer capacitance <sup>1)</sup>	Crss	-	21	37	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	14	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =56 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =56 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Turn-off delay time	$t_{\sf d(off)}$	-	20	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =56 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =56 A, $R_{\rm G,ext}$ =1.6 $\Omega$	

Table 6 Gate charge characteristics<sup>2)</sup>

Dougnator	C: mah al		Values			Nata (Table Operation	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	21	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =56 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	10	15	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =56 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	17	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =56 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	Qg	-	49	61	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =56 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =56 A, $V_{\rm GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	136	181	nC	V <sub>DD</sub> =75 V, V <sub>GS</sub> =0 V	

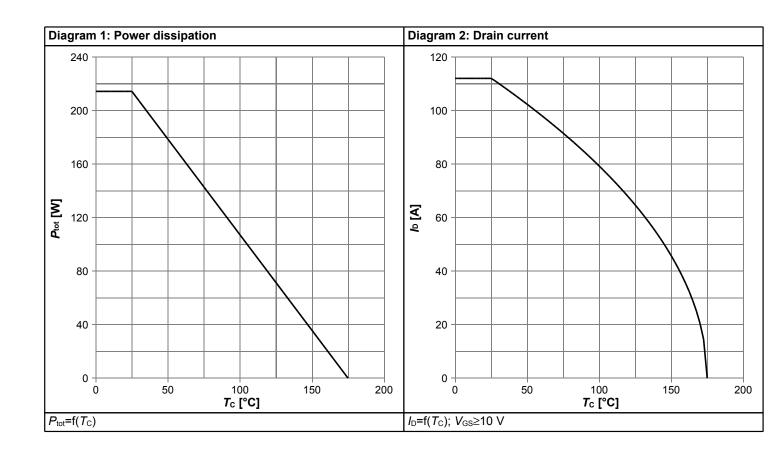
### Table 7 Reverse diode

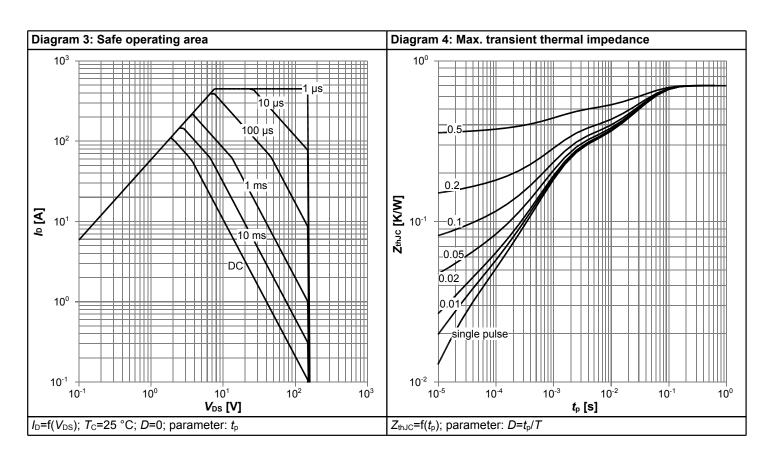
Doromotor	Cumbal	Values		s	Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	112	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	448	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.89	1.1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =56 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	69	138	ns	V <sub>R</sub> =75 V, I <sub>F</sub> =56 A, di <sub>F</sub> /dt=100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	96	192	nC	$V_R$ =75 V, $I_F$ =56 A, $di_F/dt$ =100 A/ $\mu$ s	

 $<sup>^{\</sup>rm 1)}$  Defined by design. Not subject to production test.  $^{\rm 2)}$  See "Gate charge waveforms" for parameter definition

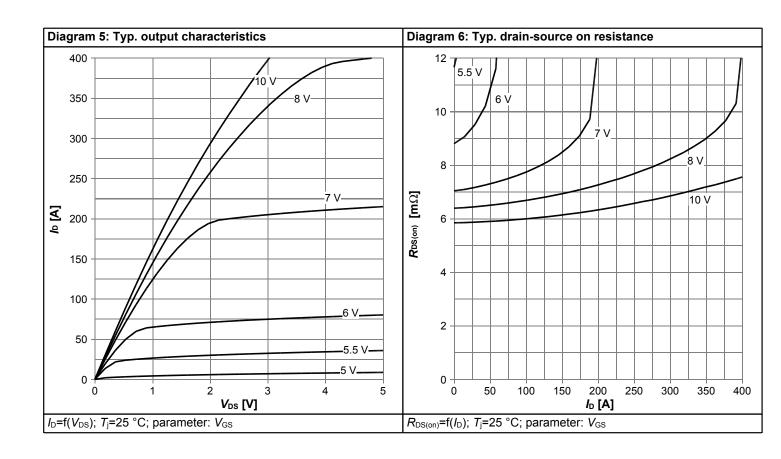


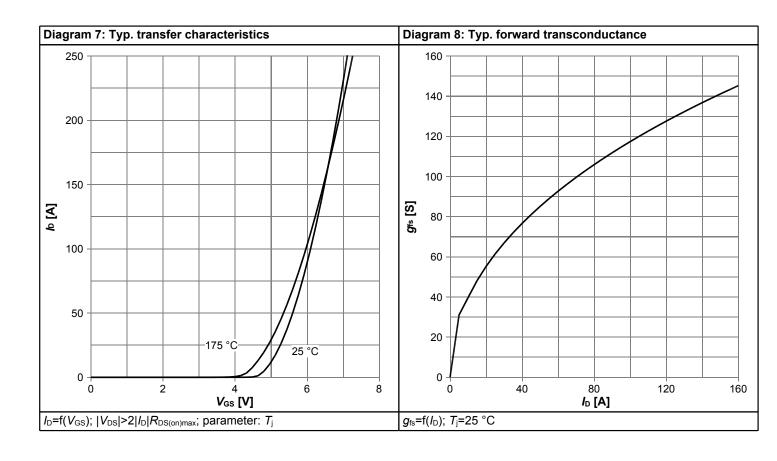
## 4 Electrical characteristics diagrams



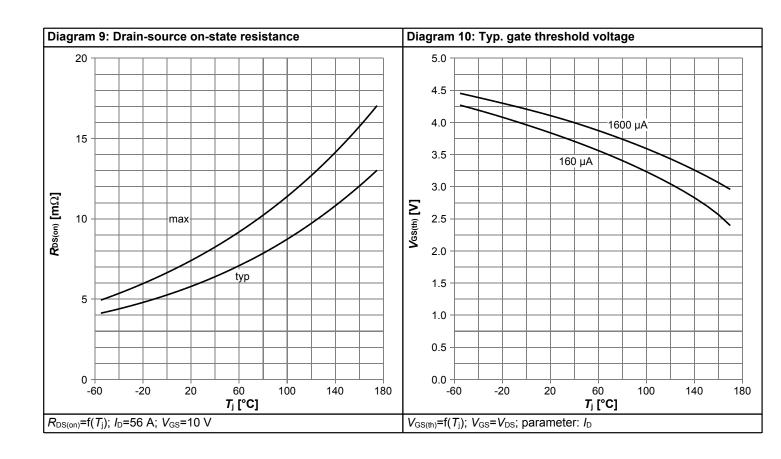


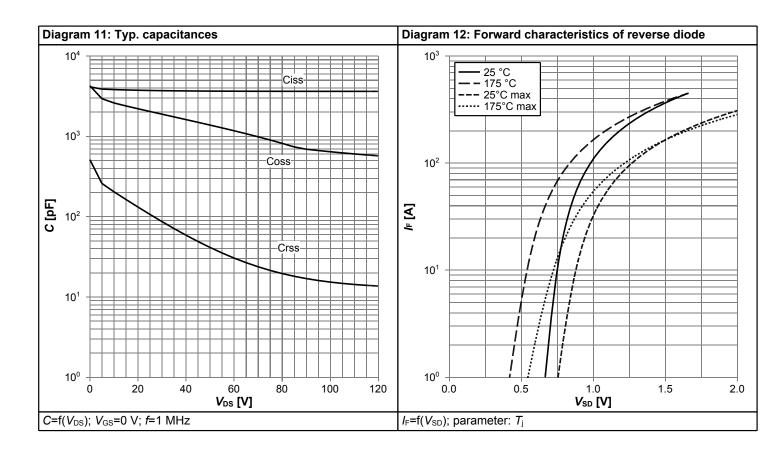




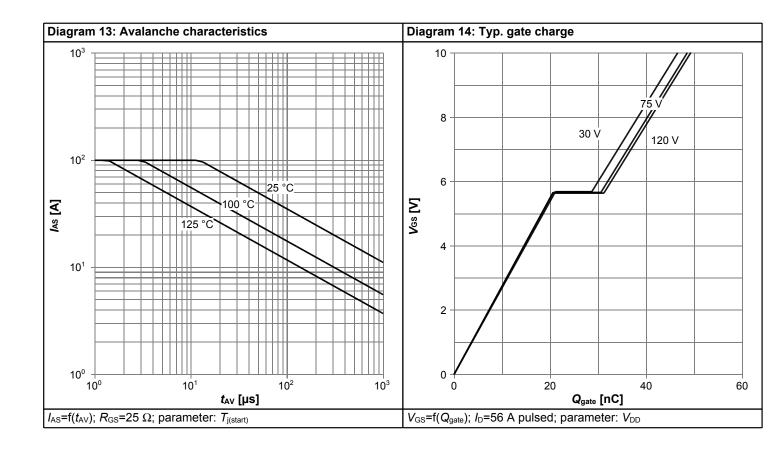


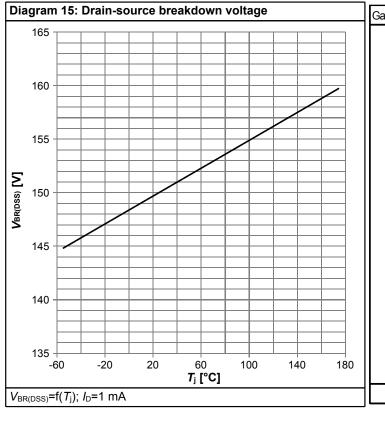


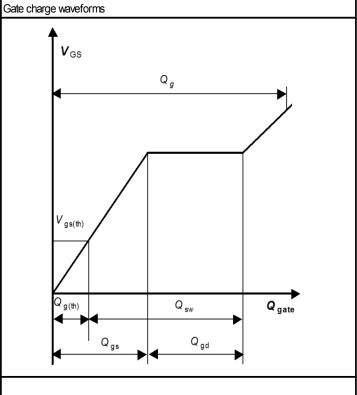






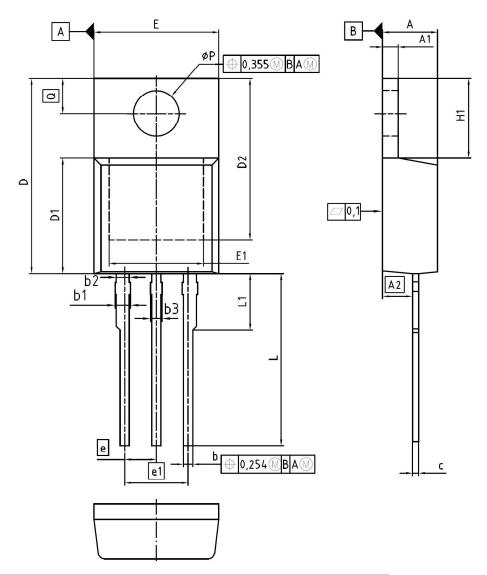








# 5 Package Outlines



DIM	MILLIM	ETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	4.30	4.57	0.169	0.180			
A1	1.17	1.40	0.046	0.055			
A2	2.15	2.72	0.085	0.107			
b	0.65	0.86	0.026	0.034			
b1	0.95	1.40	0.037	0.055			
b2	0.95	1.15	0.037	0.045			
b3	0.65	1.15	0.026	0.045			
С	0.33	0.60	0.013	0.024			
D	14.81	15.95	0.583	0.628			
D1	8.51	9.45	0.335	0.372			
D2	12.19	13.10	0.480	0.516			
Ε	9.70	10.36	0.382	0.408			
E1	6.50	8.60	0.256	0.339			
е	2.	54	0.100				
e1	5.0	08	0.200				
N		3	;	3			
H1	5.90	6.90	0.232	0.272			
L	13.00	14.00	0.512	0.551			
L1	-	4.80	-	0.189			
øΡ	3.60	3.89	0.142	0.153			
Q	2.60	3.00	0.102	0.118			

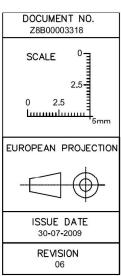


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V IPP076N15N5



### **Revision History**

IPP076N15N5

Revision: 2016-03-03, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2016-03-03	Release of final version

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